

5A, 200V-1000V Fast Recovery Surface Mount Rectifier

FEATURES

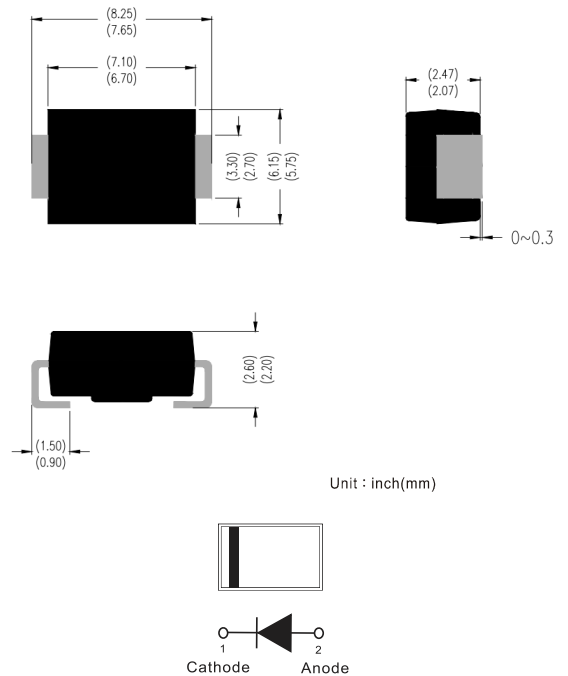
- Glass passivated junction chip
- Ideal for automated placement
- Low reverse leakage
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switch Mode Power Supply
- Inverters and Converters
- Free Wheeling diodes

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.25 g (approximately)

DO-214AB (SMC)


ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	RS5D	RS5G	RS5J	RS5K	RS5M	UNIT
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V
DC blocking voltage	V_{DC}	200	400	600	800	1000	V
Forward current	I_F	5					A
Surge peak forward current single half sine-wave superimposed on rated load	8.3 ms at $T_A = 25^\circ\text{C}$	164					A
	1.0 ms at $T_A = 25^\circ\text{C}$	364					A
Junction temperature	T_J	-55 to +150					$^\circ\text{C}$
Storage temperature	T_{STG}	-55 to +150					$^\circ\text{C}$

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	25	$^{\circ}C/W$
Junction-to-ambient thermal resistance	$R_{\theta JA}$	54	$^{\circ}C/W$
Junction-to-case thermal resistance	$R_{\theta JC}$	18	$^{\circ}C/W$

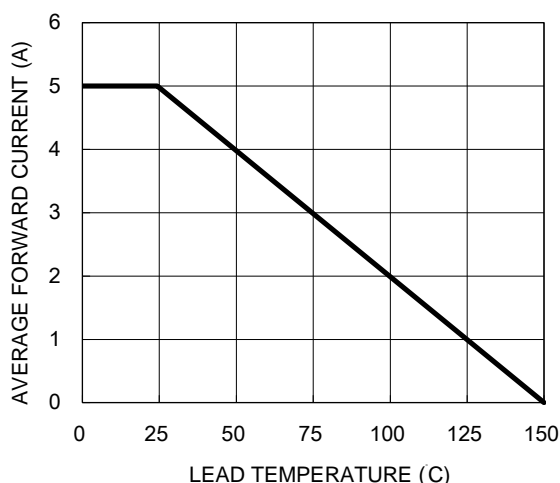
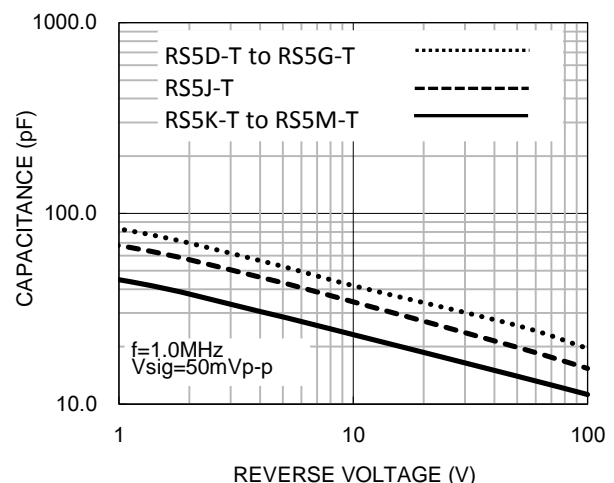
Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	RS5D to RS5G	$I_F = 2.5A, T_J = 25^{\circ}C$	V_F	0.86	-	V
		$I_F = 5A, T_J = 25^{\circ}C$		0.93	1.3	V
		$I_F = 2.5A, T_J = 125^{\circ}C$		0.72	-	V
		$I_F = 5A, T_J = 125^{\circ}C$		0.79	0.91	V
	RS5J	$I_F = 2.5A, T_J = 25^{\circ}C$		0.91	-	V
		$I_F = 5A, T_J = 25^{\circ}C$		0.98	1.3	V
		$I_F = 2.5A, T_J = 125^{\circ}C$		0.77	-	V
		$I_F = 5A, T_J = 125^{\circ}C$		0.85	1.0	V
	RS5K to RS5M	$I_F = 2.5A, T_J = 25^{\circ}C$		0.97	-	V
		$I_F = 5A, T_J = 25^{\circ}C$		1.06	1.3	V
		$I_F = 2.5A, T_J = 125^{\circ}C$		0.82	-	V
		$I_F = 5A, T_J = 125^{\circ}C$		0.91	1.04	V
Reverse current @ rated V_R ⁽²⁾		$T_J = 25^{\circ}C$	I_R	-	10	μA
		$T_J = 125^{\circ}C$		-	200	μA
Reverse recovery time	RS5D to RS5G	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$	t_{rr}	-	150	ns
	RS5J			-	250	ns
	RS5K to RS5M			-	500	ns
Junction capacitance	RS5D to RS5G	1 MHz, $V_R = 4.0V$	C_J	57	-	pF
	RS5J			46	-	pF
	RS5K to RS5M			31	-	pF

Notes: (1) Pulse test with $PW = 0.3$ ms (2) Pulse test with $PW = 30$ ms

CHARACTERISTICS CURVES ($T_A = 25^{\circ}C$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

Fig.2 Typical Junction Capacitance




CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.3 Typical Reverse Characteristics

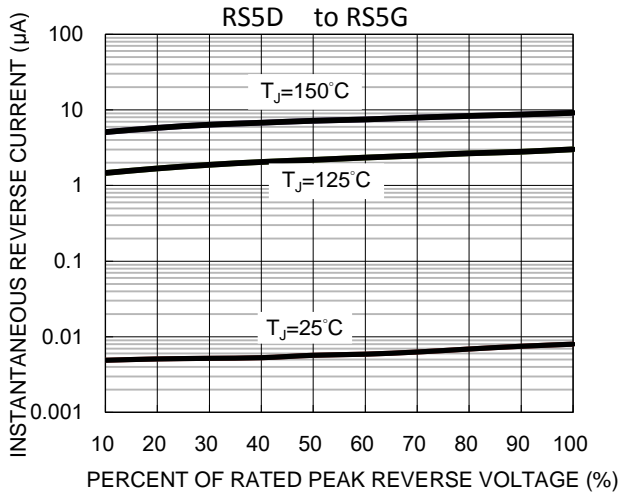


Fig.4 Typical Forward Characteristics

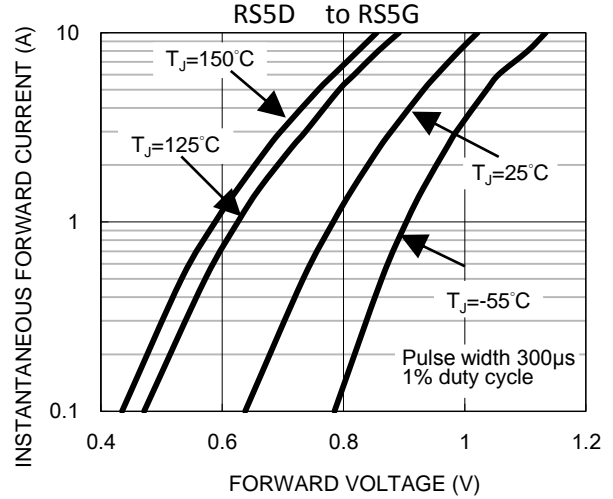


Fig.5 Typical Reverse Characteristics

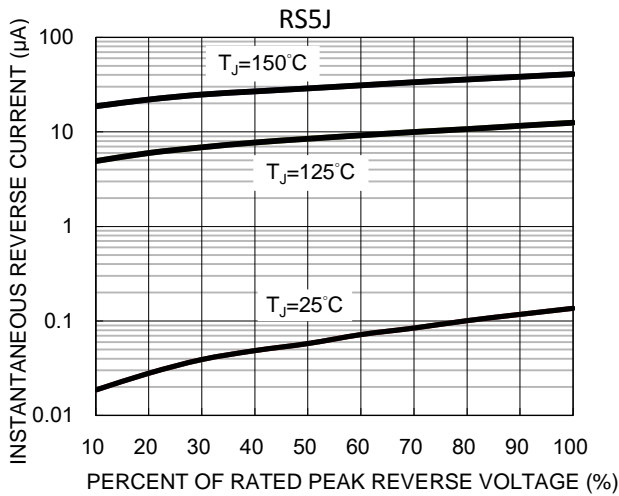


Fig.6 Typical Forward Characteristics

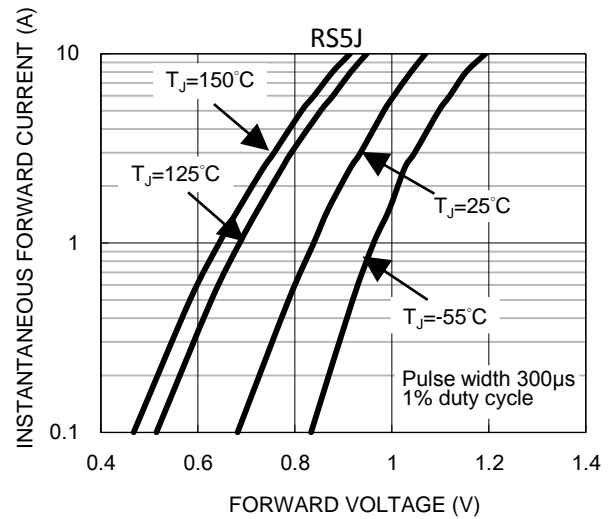


Fig.7 Typical Reverse Characteristics

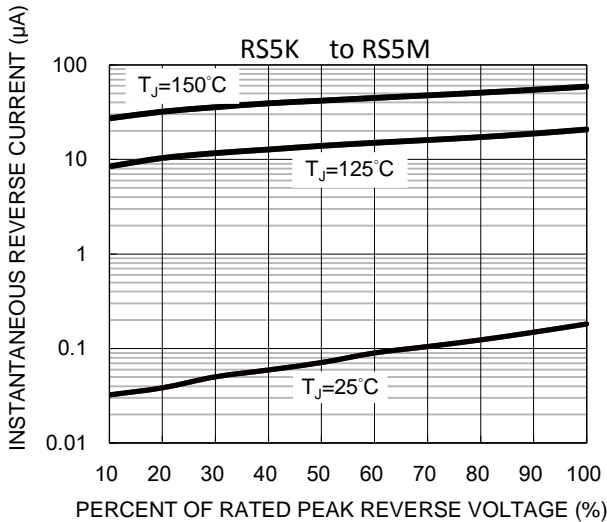


Fig.8 Typical Forward Characteristics

